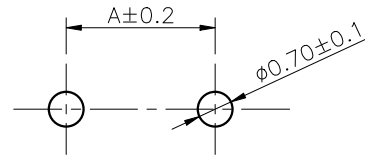
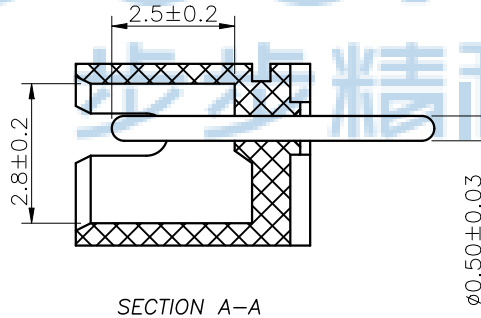
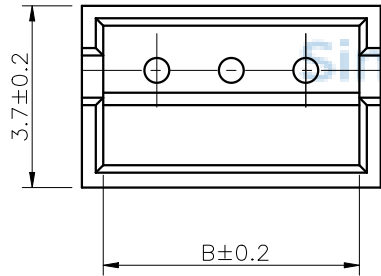
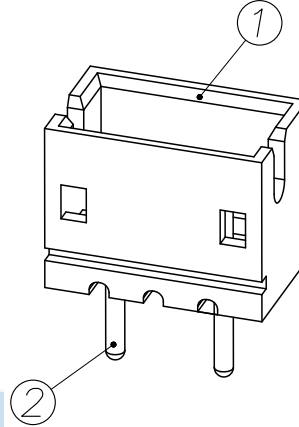
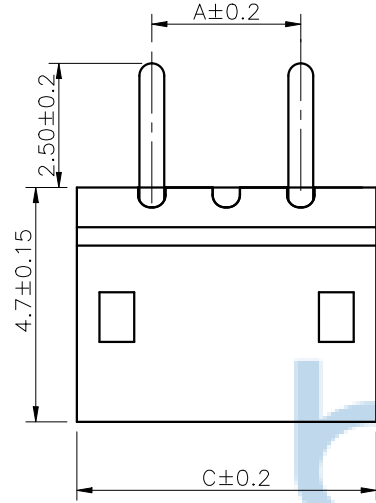


REV	ECN NO	CONTENT	DATE	ENGINEER
AO		INITIAL RELEASE	/	SGF

技术参数:

- 1、额定电流: 1A, AC, DC;
- 2、额定电压: 50V, AC, DC;
- 3、温度范围: -25℃~+85℃;
- 4、接触电阻: $\leq 0.02\Omega$;
- 5、绝缘电阻: $\geq 500M\Omega$;
- 6、耐压: 500V, AC/minute.
- 7、适用线规: AWG#32 to #26



SUGGESTED PCB LAYOUT
(COMPONENT SIDE)



Circuits	Dimensions (mm)		
	A	B	C
02	1.50	3.60	4.50
03	3.00	5.10	6.00
04	4.50	6.60	7.50
05	6.00	8.10	9.00
06	7.50	9.60	10.50
07	9.00	11.10	12.00
08	10.50	12.60	13.50
09	12.00	14.10	15.00
10	13.50	15.60	16.50
11	15.00	17.10	18.00
12	16.50	18.60	19.50
13	18.00	20.10	21.00
14	19.50	21.60	22.50
15	21.00	23.10	24.00
16	22.50	24.60	25.50

2	端子 Contact	黄铜 Brass	n*1	镀锡
1	基座 Wafer	PA66 (UL94V-0)	1	米色
序号	名称	材料	数量	附注

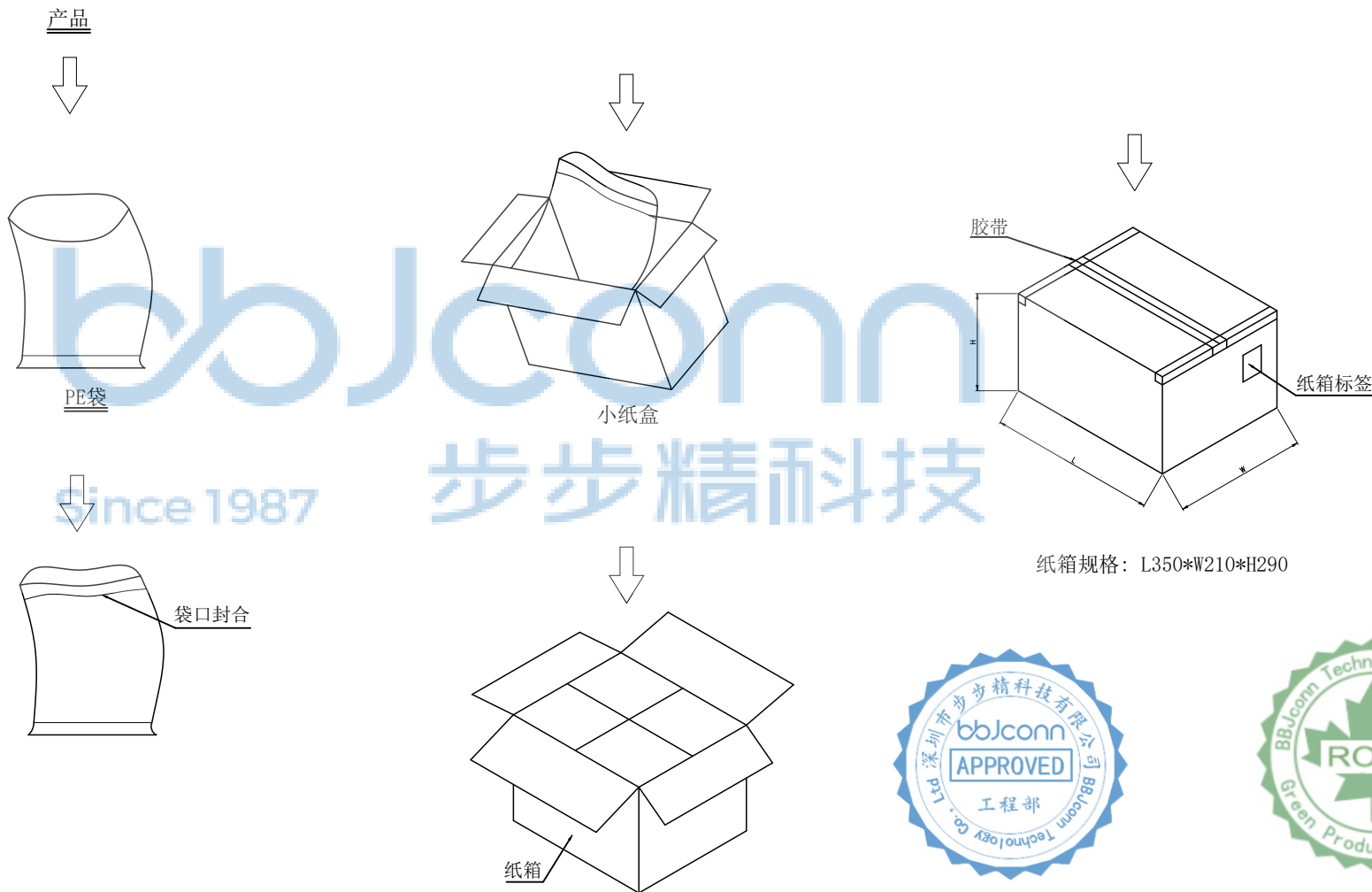
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PDWG NO: 0510-1

深圳市步步精科技有限公司

.X: ±0.38 .XX: ±0.25 .XXX: ±0.13		X': ±3" X'': ±2" XX': ±1"		NAME: 针座 ZH1.5-3A2T 中间空1P 直针 米色 袋装				
APPD	JM_Zheng				PJ NO: 123-265-030001-Y3G			
CHKD	LYX				SIZE:A4	DRW NO:		
DR	SGF				FINISH:SEE NOTES		MAT'L:SEE NOTES	
					SCALE:N/A	REV:A0	UNIT:mm	PAGE:1/

REV.	ECN NO	CONTENT	DATE	ENGINEER
A0		INITIAL RELEASE	/	SGF



1、包装要求:

- 1.1 PE袋包装1000pcs;
- 1.2 每1袋放一小纸盒;
- 1.3 每20个小纸盒放一个纸箱, 共计20000pcs ;
- 1.4 纸箱外贴上标签

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.X: ±0.38 X*: ±3*
.XX: ±0.25 .X*: ±2*
.XXX: ±0.13 .XX*: ±1*

APPD JM_Zheng

CHKD LYX

DR SGF

NAME:
针座 ZH1.5-3A2T 中间空1P 直针 米色 袋装

PJ NO: 123-265-030001-Y3G

SIZE:A4 DRW NO:

FINISH:SEE NOTES MAT'L:SEE NOTES

SCALE:N/A REV: A0 UNIT:mm PAGE: 2/2